

# SOD-123FL Plastic-Encapsulate Diodes

## Schottky Rectifier Diodes

### Features:

- $I_{F(AV)}$  3A
- $V_{RRM}$  20V-200V
- High surge current capability
- Polarity: Color band denotes cathode

SOD-123FL



### Applications:

- Rectifier

### Marking

- KWSMD32PL-KWSMD320PL : K32-K320

### Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	KWSMD3														
				2PL	3PL	4PL	5PL	6PL	8PL	10PL	15PL	20PL						
Repetitive Peak Reverse Voltage	$V_{RRM}$	V		20	30	40	50	60	80	100	150	200						
Maximum RMS Voltage	$V_{RMS}$	V		14	21	28	35	42	56	70	105	140						
Average Forward Current	$I_{F(AV)}$	A	60Hz Half-sine wave , Resistance load , TL=(Fig.1 )	3.0														
Surge(Non-repetitive)Forward Current	$I_{FSM}$	A	60Hz Half-sine wave , 1 cycle , Ta=25°C	80														
Junction Temperature	$T_J$	°C		-55 ~ +150														
Storage Temperature	$T_{STG}$	°C		-55 ~ +150														

### Electrical Characteristics (T=25 °C Unless otherwise specified )

Item	Symbol	Unit	Test Condition	KWSMD3														
				2PL	3PL	4PL	5PL	6PL	8PL	10PL	15PL	20PL						
Peak Forward Voltage	$V_{FM}$	V	$I_{FM}=3.0A$	0.55		0.7		0.85		0.95								
Peak Reverse Current	$I_{RRM1}$	mA	$V_{RM}=V_{RRM}$	$T_a = 25^\circ C$		0.5		0.1										
	$I_{RRM2}$			$T_a = 100^\circ C$		10		5.0										
Thermal Resistance(Typical)	$R_{\theta J-A}$	°C/W	Between junction and ambient	70														
	$R_{\theta J-L}$		Between junction and terminal	25														

### Notes:

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

## Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

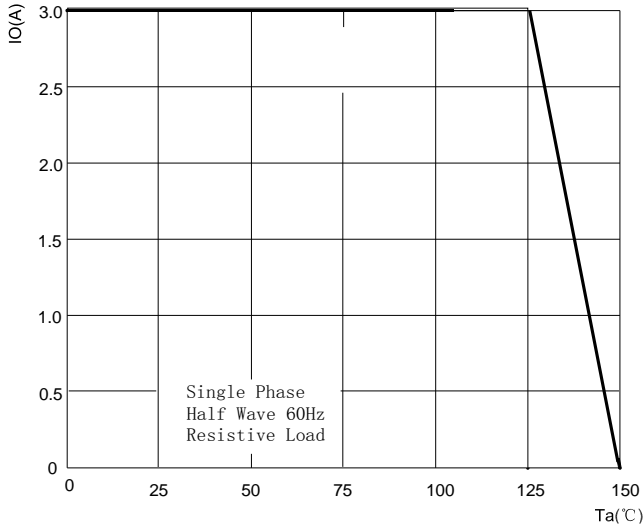


FIG.2: MAXIMUM NON-REPETITIVE FORWARD URGE CURRENT

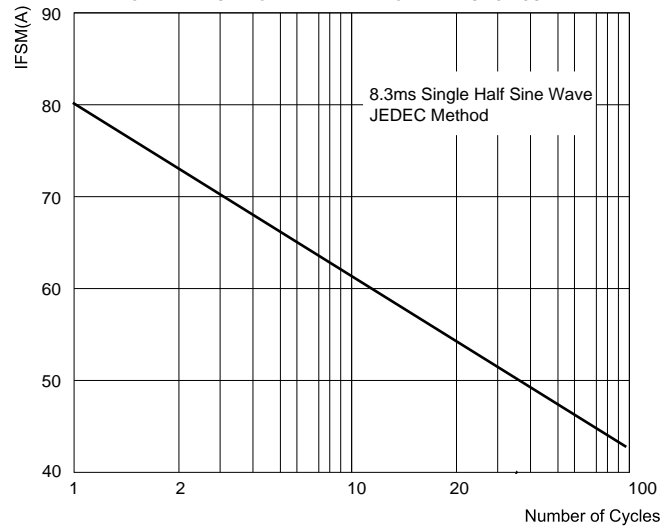


FIG.3: TYPICAL FORWARD CHARACTERISTICS

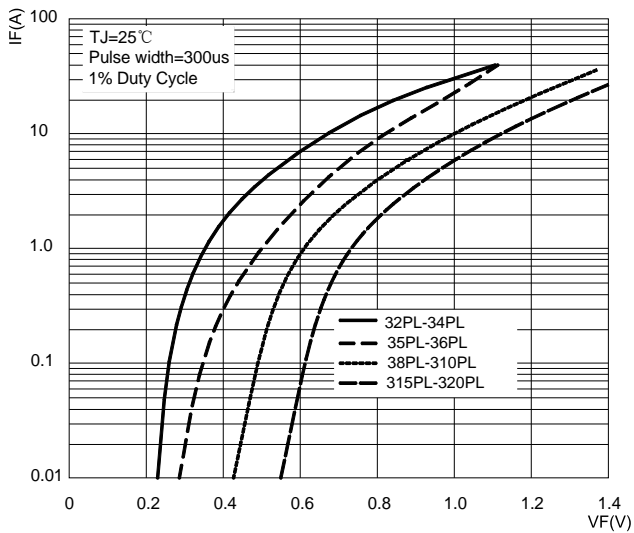


FIG.4: TYPICAL REVERSE CHARACTERISTICS

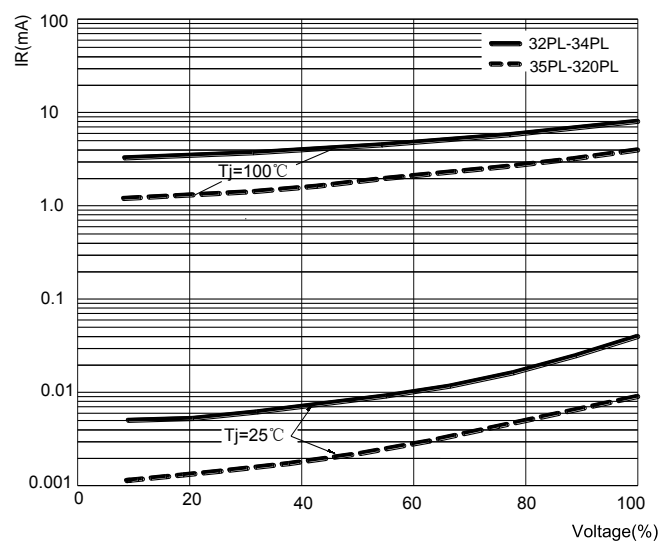
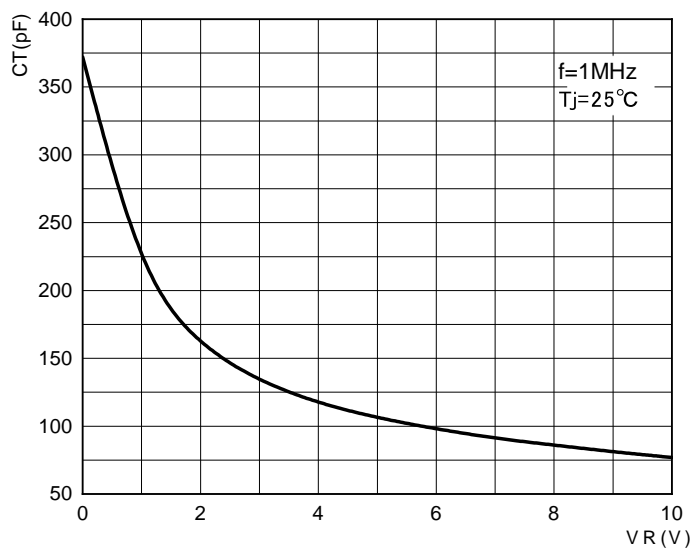
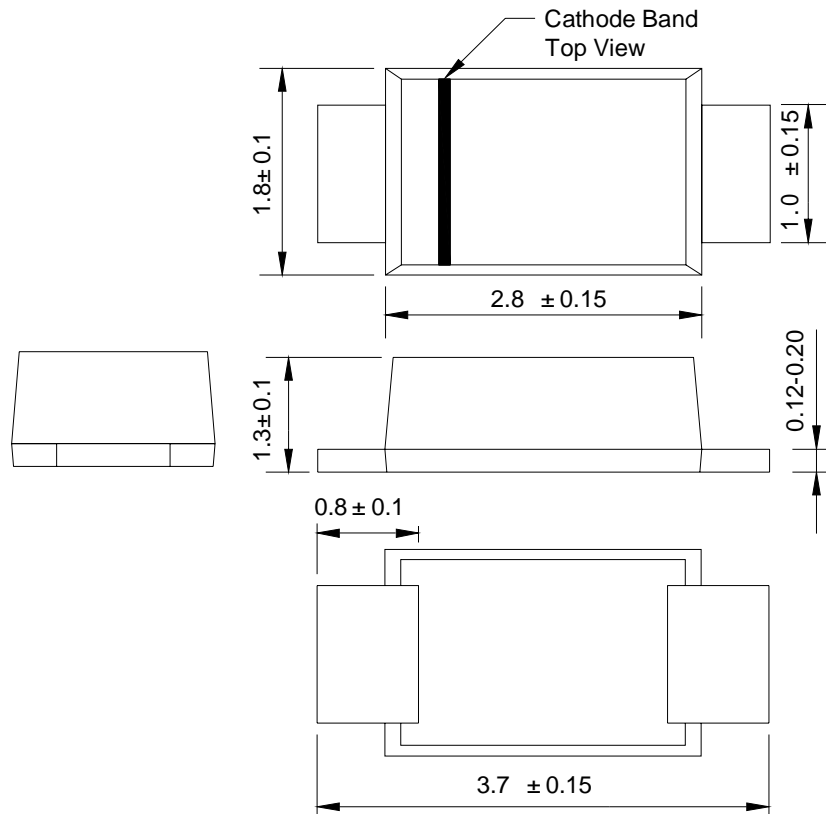


FIG.5: TOTAL CAPACITANCE DERATING CURVE

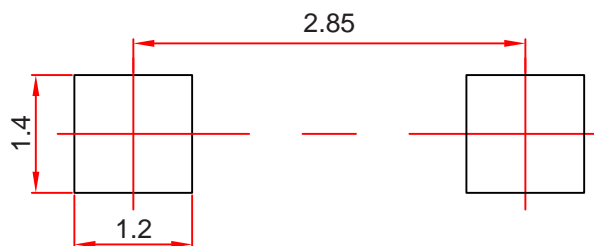


### SOD-123FL Package Outline Dimensions



Dimensions in millimeters

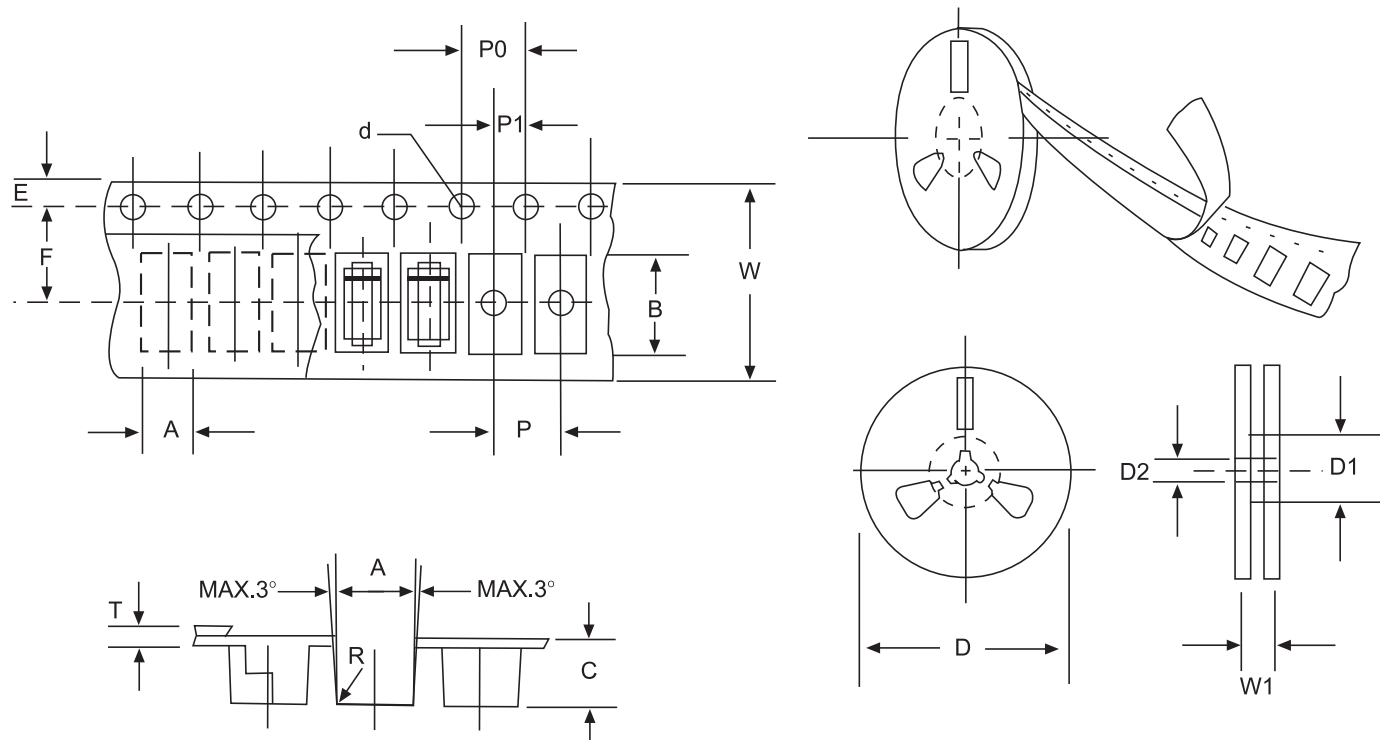
### SOD-123FL Suggested Pad Layout



**Note:**

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05$  mm.
3. The pad layout is for reference purposes only.

## Reel Taping Specifications For Surface Mount Devices-SOD-123FL



**FIG: CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING**

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Stroket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Totall tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE: Devices are packde in accordance with EIA standard RS-481-A and specification given above.